

Vorläufige Daten
preliminary data**IGBT-Wechselrichter/IGBT-inverter****Höchstzulässige Werte/maximum rated values**

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}$	$I_{C\text{ nom}}$ I_C	10 16	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_P = 1\text{ ms}$, $T_C = 80^{\circ}\text{C}$	I_{CRM}	20	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^{\circ}\text{C}$	P_{tot}	78,0	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte/characteristic values

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$I_C = 10\text{ A}$, $V_{GE} = 15\text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $I_C = 10\text{ A}$, $V_{GE} = 15\text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	$V_{CE\text{ sat}}$		1,95 2,20	2,55	V V
Gate-Schwellenspannung gate threshold voltage	$I_C = 0,40\text{ mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25^{\circ}\text{C}$	V_{GEth}	4,5	5,5	6,5	V
Gateladung gate charge	$V_{GE} = -15\text{ V} \dots +15\text{ V}$	Q_G		0,05		μC
Interner Gatewiderstand internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		0,0		Ω
Eingangskapazität input capacitance	$f = 1\text{ MHz}$, $T_{vj} = 25^{\circ}\text{C}$, $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$	C_{ies}		0,45		nF
Rückwirkungskapazität reverse transfer capacitance	$f = 1\text{ MHz}$, $T_{vj} = 25^{\circ}\text{C}$, $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$	C_{res}		0,04		nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{CE} = 600\text{ V}$, $V_{GE} = 0\text{ V}$, $T_{vj} = 25^{\circ}\text{C}$	I_{CES}			5,0	mA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$, $T_{vj} = 25^{\circ}\text{C}$	I_{GES}			400	nA
Einschaltverzögerungszeit (ind. Last) turn-on delay time (inductive load)	$I_C = 10\text{ A}$, $V_{CE} = 300\text{ V}$ $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\text{ }\Omega$, $T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\text{ }\Omega$, $T_{vj} = 125^{\circ}\text{C}$	$t_{d\text{ on}}$		0,012 0,012		μs μs
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 10\text{ A}$, $V_{CE} = 300\text{ V}$ $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\text{ }\Omega$, $T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\text{ }\Omega$, $T_{vj} = 125^{\circ}\text{C}$	t_r		0,012 0,013		μs μs
Abschaltverzögerungszeit (ind. Last) turn-off delay time (inductive load)	$I_C = 10\text{ A}$, $V_{CE} = 300\text{ V}$ $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 27\text{ }\Omega$, $T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 27\text{ }\Omega$, $T_{vj} = 125^{\circ}\text{C}$	$t_{d\text{ off}}$		0,085 0,105		μs μs
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 10\text{ A}$, $V_{CE} = 300\text{ V}$ $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 27\text{ }\Omega$, $T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 27\text{ }\Omega$, $T_{vj} = 125^{\circ}\text{C}$	t_f		0,017 0,03		μs μs
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = 10\text{ A}$, $V_{CE} = 300\text{ V}$, $L_S = 60\text{ nH}$ $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\text{ }\Omega$, $T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\text{ }\Omega$, $T_{vj} = 125^{\circ}\text{C}$	E_{on}		0,18 0,25		mJ mJ
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = 10\text{ A}$, $V_{CE} = 300\text{ V}$, $L_S = 60\text{ nH}$ $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 27\text{ }\Omega$, $T_{vj} = 25^{\circ}\text{C}$ $V_{GE} = \pm 15\text{ V}$, $R_{Goff} = 27\text{ }\Omega$, $T_{vj} = 125^{\circ}\text{C}$	E_{off}		0,18 0,27		mJ mJ
Kurzschlußverhalten SC data	$t_P \leq 10\text{ }\mu\text{s}$, $V_{GE} \leq 15\text{ V}$ $T_{vj} \leq 125^{\circ}\text{C}$, $V_{CC} = 360\text{ V}$, $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	I_{SC}		45		A
Innerer Wärmewiderstand thermal resistance, junction to case	pro IGBT per IGBT	R_{thJC}		1,60	1,80	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro IGBT / per IGBT $\lambda_{Paste} = 1\text{ W/(m}\cdot\text{K)}$ / $\lambda_{grease} = 1\text{ W/(m}\cdot\text{K)}$	R_{thCH}		0,80		K/W

prepared by: Peter Kanschäat

date of publication: 2003-6-27

approved by: Ralf Keggenhoff

revision: 2.1

Vorläufige Daten
preliminary data**Diode-Wechselrichter/diode-inverter****Höchstzulässige Werte/maximum rated values**

Periodische Spitzensperrspannung repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	600	V
Dauergleichstrom DC forward current		I_F	10	A
Periodischer Spitzenstrom repetitive peak forward current	$t_P = 1 \text{ ms}$	I_{FRM}	20	A
Grenzlastintegral I^2t - value	$V_R = 0 \text{ V}$, $t_P = 10 \text{ ms}$, $T_{vj} = 125^{\circ}\text{C}$	I^2t	12,0	A^2s

Charakteristische Werte/characteristic values

			min.	typ.	max.	
Durchlassspannung forward voltage	$I_F = 10 \text{ A}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $I_F = 10 \text{ A}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	V_F		1,85 1,90	2,25	V V
Rückstromspitze peak reverse recovery current	$I_F = 10 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$ $V_R = 300 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $V_R = 300 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	I_{RM}		16,0 17,0		A A
Sperrverzögerungsladung recovered charge	$I_F = 10 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$ $V_R = 300 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $V_R = 300 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	Q_r		0,50 0,85		μC μC
Abschaltenergie pro Puls reverse recovery energy	$I_F = 10 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$ $V_R = 300 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 25^{\circ}\text{C}$ $V_R = 300 \text{ V}$, $V_{GE} = -15 \text{ V}$, $T_{vj} = 125^{\circ}\text{C}$	E_{rec}		0,10 0,18		mJ mJ
Innerer Wärmewiderstand thermal resistance, junction to case	pro Diode per diode	R_{thJC}		3,60	3,95	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Diode / per diode $\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$	R_{thCH}		1,35		K/W

NTC-Widerstand/NTC-thermistor**Charakteristische Werte/characteristic values**

			min.	typ.	max.	
Nennwiderstand rated resistance	$T_C = 25^{\circ}\text{C}$	R_{25}		5,00		k Ω
Abweichung von R_{100} deviation of R_{100}	$T_C = 100^{\circ}\text{C}$, $R_{100} = 493 \Omega$	$\Delta R/R$	-5		5	%
Verlustleistung power dissipation	$T_C = 25^{\circ}\text{C}$	P_{25}			20,0	mW
B-Wert B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298, 15\text{K}))]$	$B_{25/50}$		3375		K

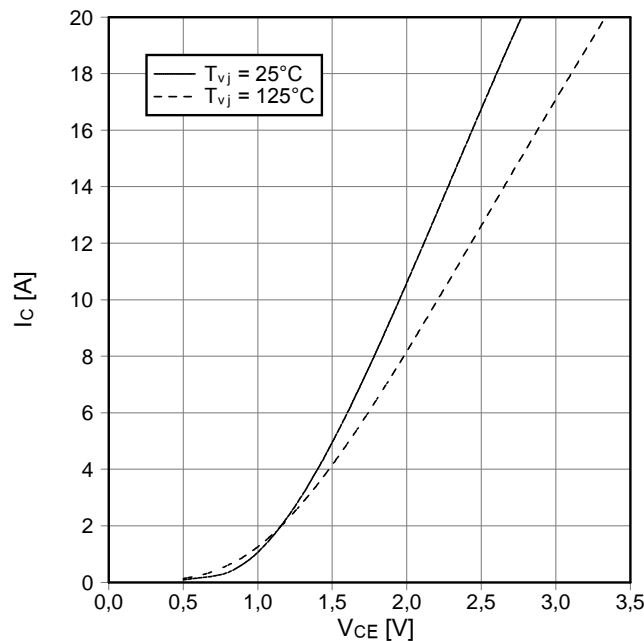
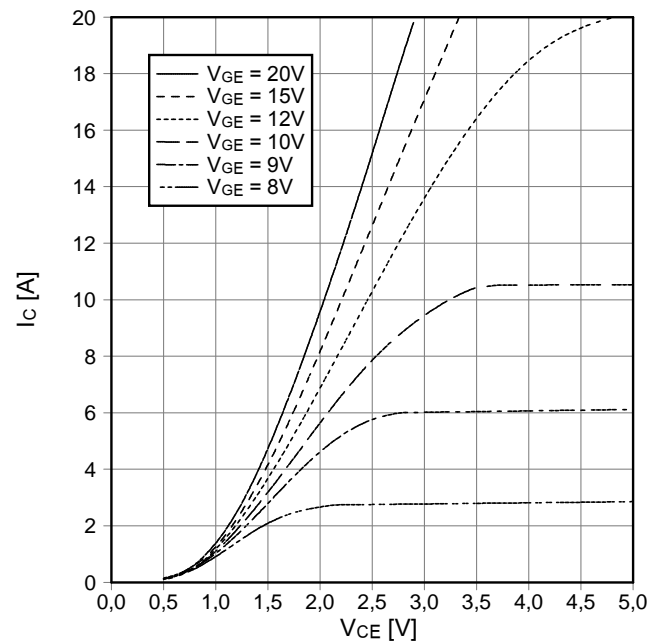
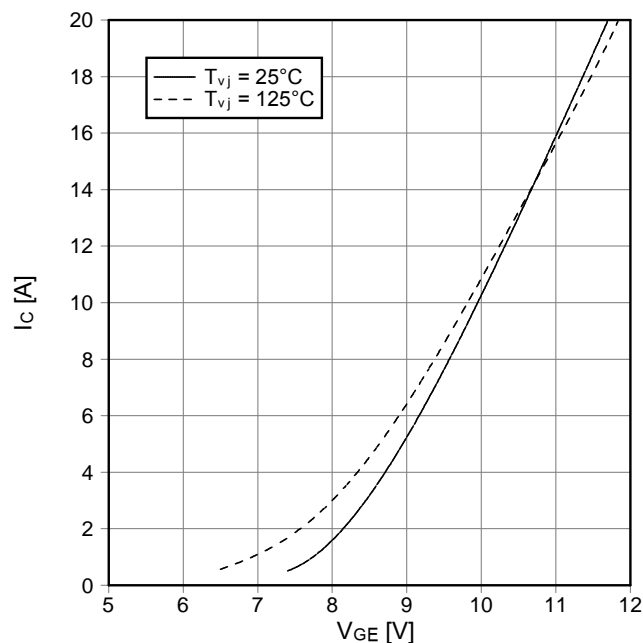
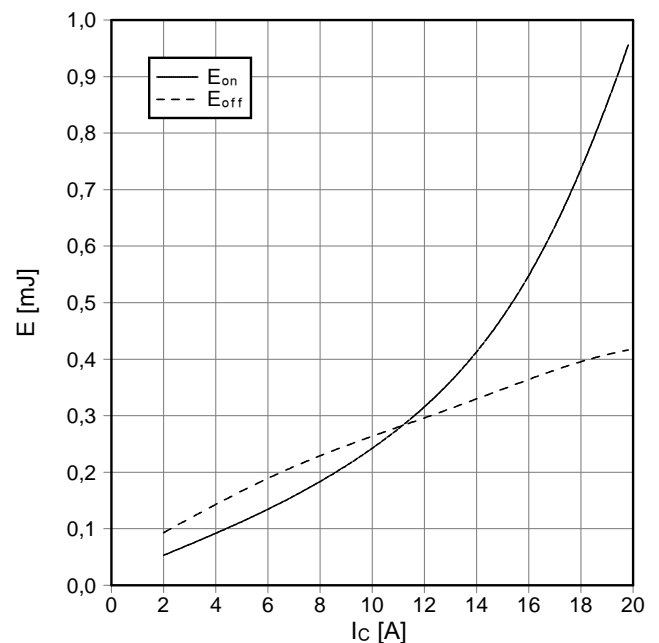
Vorläufige Daten
preliminary data**Modul/module**

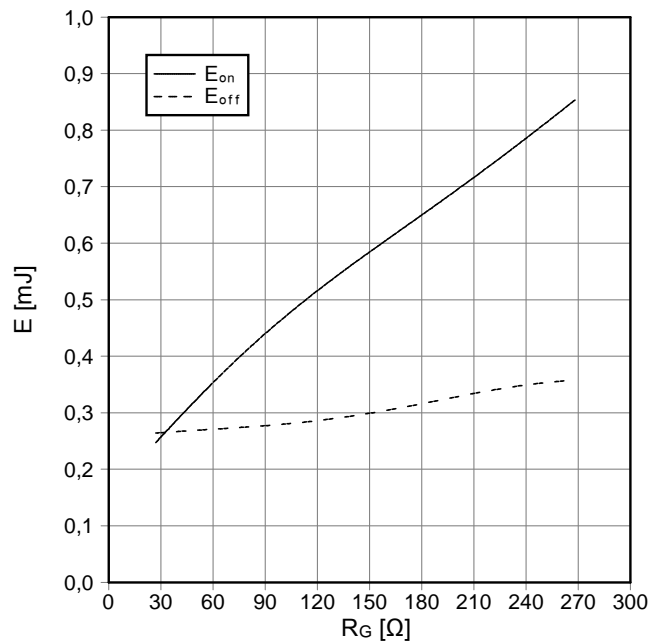
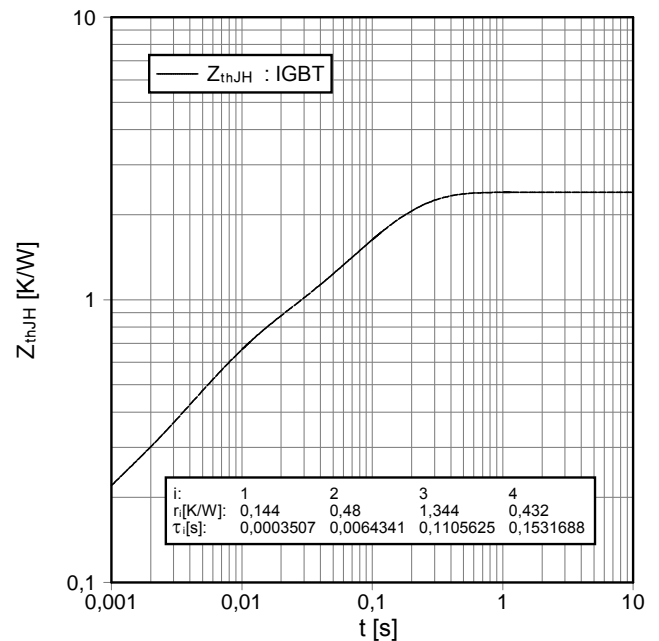
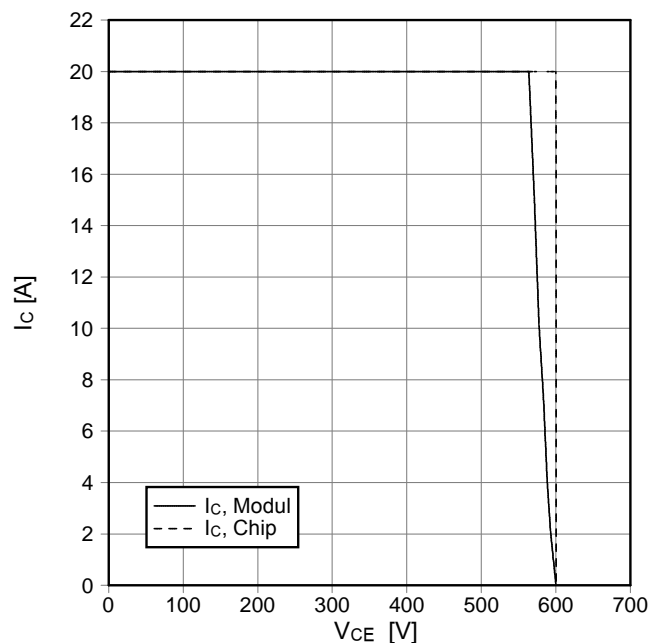
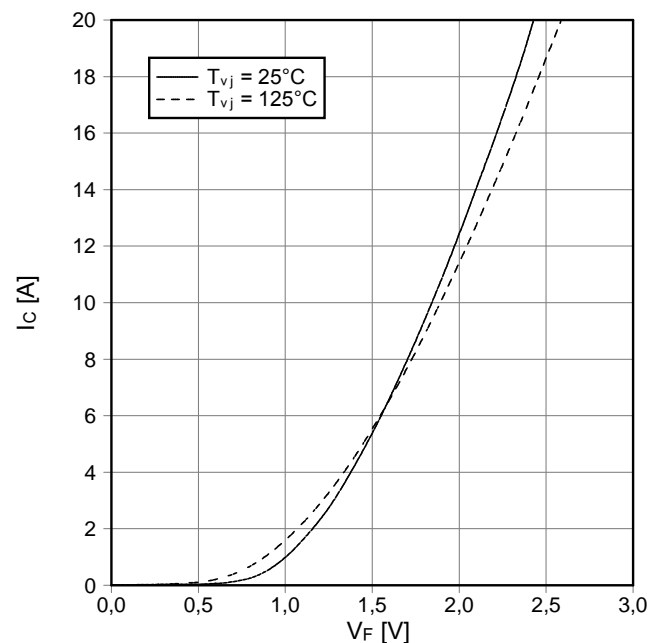
Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min.	V _{ISOL}	2,5	kV
Kollektor-Emitter-Gleichsperrspannung DC stability	T _{vj} = 25°C, 100 fit	V _{CE D}	600	V
Material für innere Isolation material for internal insulation			Al ₂ O ₃	
Kriechstrecke creepage distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal		5,00 5,00	mm
Luftstrecke clearance distance	Kontakt - Kühlkörper / terminal to heatsink Kontakt - Kontakt / terminal to terminal		3,20 3,20	mm
Vergleichszahl der Kriechwegbildung comparative tracking index		CTI	> 225	
Modulinduktivität stray inductance module		L _{sCE}	min. 25 max.	nH
Modulleitungswiderstand, Anschlüsse - Chip module lead resistance, terminals - chip	T _C = 25°C, pro Zweig / per arm	R _{CC'+EE'}	9,50	mΩ
Höchstzulässige Sperrschichttemperatur maximum junction temperature		T _{vj max}	150	°C
Temperatur im Schaltbetrieb temperature under switching conditions		T _{vj op}	-40 125	°C
Lagertemperatur storage temperature		T _{stg}	-40 125	°C
Anpreßkraft für mech. Bef. pro Feder mounting force per clamp		F	30 - 50	N
Gewicht weight		G	10	g

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

This technical information specifies semiconductor devices but guarantees no characteristics. It is valid with the appropriate technical explanations.

prepared by: Peter Kanschat	date of publication: 2003-6-27
approved by: Ralf Keggenhoff	revision: 2.1

Vorläufige Daten
preliminary data**Ausgangskennlinie IGBT-Wechselr. (typisch)**
output characteristic IGBT-inverter (typical) $I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$ **Ausgangskennlinienfeld IGBT-Wechselr. (typisch)**
output characteristic IGBT-inverter (typical) $I_C = f(V_{CE})$
 $T_{vj} = 125^\circ\text{C}$ **Übertragungscharakteristik IGBT-Wechselr. (typisch)**
transfer characteristic IGBT-inverter (typical) $I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$ **Schaltverluste IGBT-Wechselr. (typisch)**
switching losses IGBT-inverter (typical) $E_{on} = f(I_C)$, $E_{off} = f(I_C)$
 $V_{GE} = \pm 15\text{ V}$, $R_{Gon} = 27\ \Omega$, $R_{Goff} = 27\ \Omega$, $V_{CE} = 300\text{ V}$,
 $T_{vj} = 125^\circ\text{C}$ 

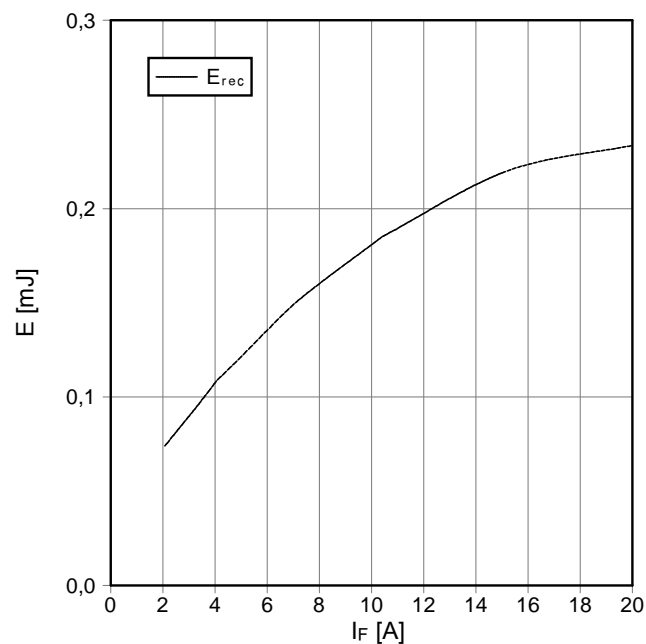
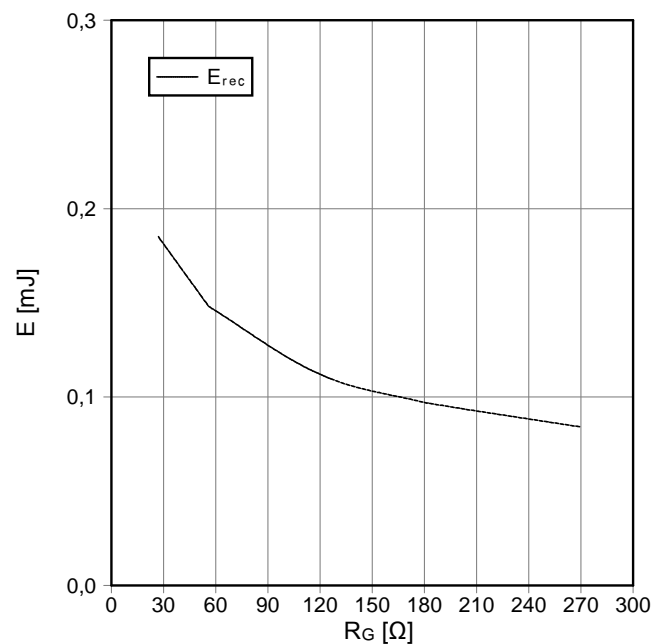
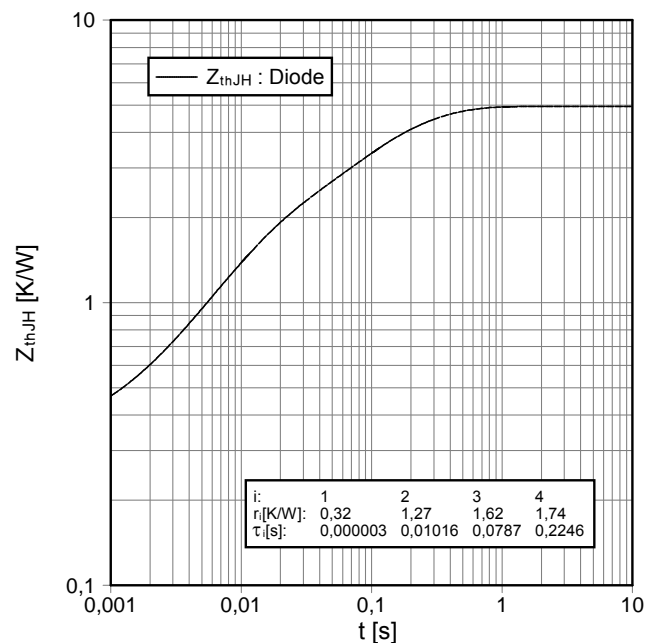
Vorläufige Daten
preliminary data**Schaltverluste IGBT-Wechselr. (typisch)**
switching losses IGBT-Inverter (typical) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$ $V_{GE} = \pm 15 \text{ V}$, $I_C = 10 \text{ A}$, $V_{CE} = 300 \text{ V}$, $T_{vj} = 125^\circ\text{C}$ **Transienter Wärmewiderstand IGBT-Wechselr.**
transient thermal impedance IGBT-inverter $Z_{thJH} = f(t)$ **Sicherer Rückwärts-Arbeitsbereich IGBT-Wr. (RBSOA)**
reverse bias safe operating area IGBT-inv. (RBSOA) $I_C = f(V_{CE})$ $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 27 \Omega$, $T_{vj} = 125^\circ\text{C}$ **Durchlaßkennlinie der Diode-Wechselr. (typisch)**
forward characteristic of diode-inverter (typical) $I_F = f(V_F)$ 

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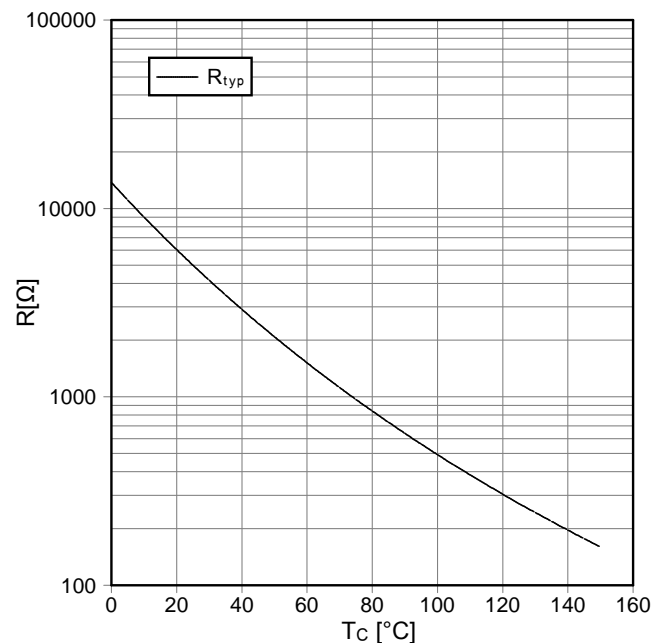
date of publication: 2003-6-27

approved by: Ralf Keggenhoff

revision: 2.1

Vorläufige Daten
preliminary data**Schaltverluste Diode-Wechselr. (typisch)**
switching losses diode-inverter (typical) $E_{rec} = f(I_F)$
 $R_{Gon} = 27 \Omega$, $V_{CE} = 300 \text{ V}$, $T_{vj} = 125^\circ\text{C}$ **Schaltverluste Diode-Wechselr. (typisch)**
switching losses diode-inverter (typical) $E_{rec} = f(R_G)$
 $I_F = 10 \text{ A}$, $V_{CE} = 300 \text{ V}$, $T_{vj} = 125^\circ\text{C}$ **Transienter Wärmewiderstand Diode-Wechselr.**
transient thermal impedance diode-inverter $Z_{thJH} = f(t)$ 

i:	1	2	3	4
r _i [K/W]:	0,32	1,27	1,62	1,74
τ _i [s]:	0,000003	0,01016	0,0787	0,2246

NTC-Temperaturkennlinie (typisch)
NTC-temperature characteristic (typical) $R = f(T)$ 

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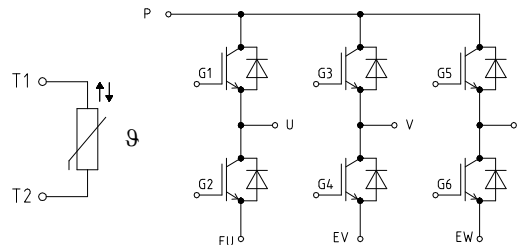
date of publication: 2003-6-27

approved by: Ralf Keggenhoff

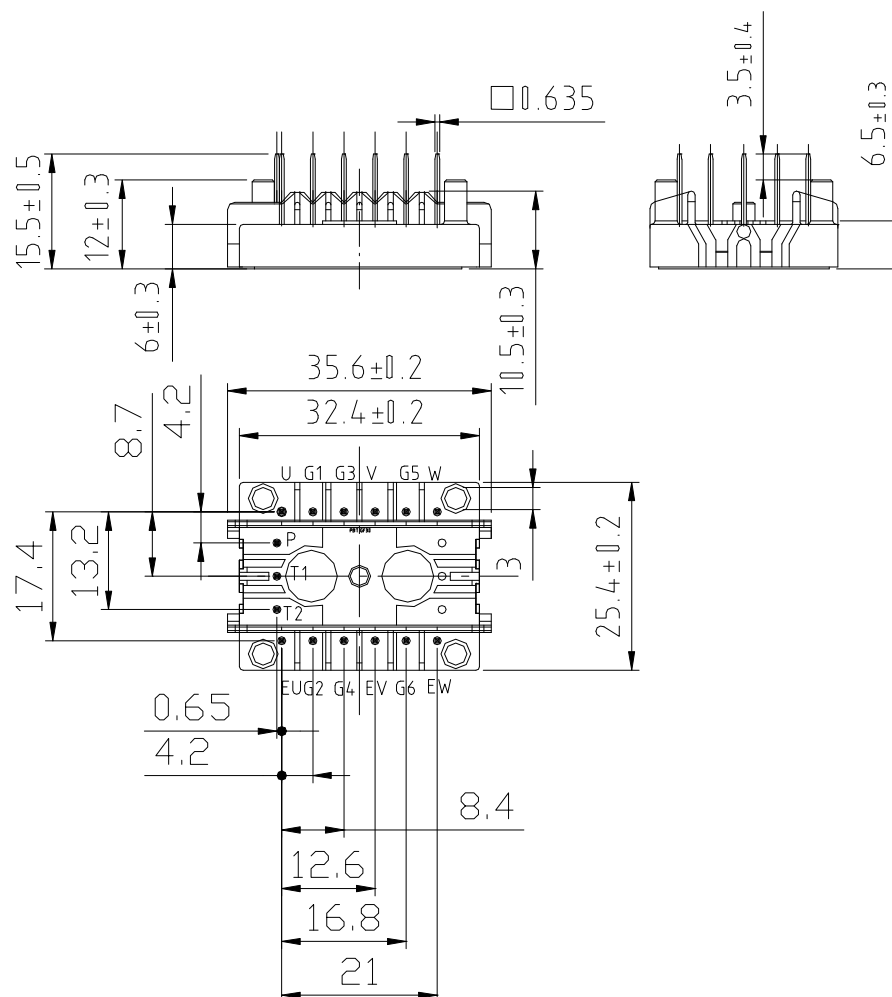
revision: 2.1

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Schaltplan/circuit diagram



Gehäuseabmessungen/package outlines



Pinpositions with tolerance



prepared by: Peter Kanschat	date of publication: 2003-6-27
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